4.0A BRIDGE RECTIFIER

SEMICONDUCTOR

Features

Diffused Junction

Data Sheet 1307, Rev.A

- Low Forward Voltage Drop
- **High Current Capability**
- **High Reliability**
- High Surge Current Capability
- Ideal for Printed Circuit Boards
- UL Recognized File # E223064

Mechanical Data

Case: Molded Plastic

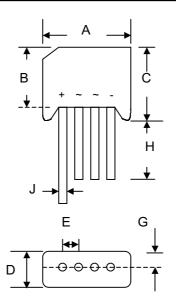
Terminals: Plated Leads Solderable per

MIL-STD-202, Method 208

Polarity: As Marked on Body Weight: 5.6 grams (approx.)

Mounting Position: Any

Marking: Type Number



KBL									
Dim	Min	Max	Min	Max					
Α	18.50	19.50	0.728	0.768					
В	13.7	14.7	0.539	0.579					
С	15.2	16.3	0.598	0.642					
D	6.0	6.50	0.236	0.256					
Е	4.60	5.60	0.181	0.220					
G	_	2.10	_	0.083					
Н	19.00	_	0.748	_					
J	1.20Ø	1.30Ø	0.05Ø	0.05Ø					
	In mm		In inch						

Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

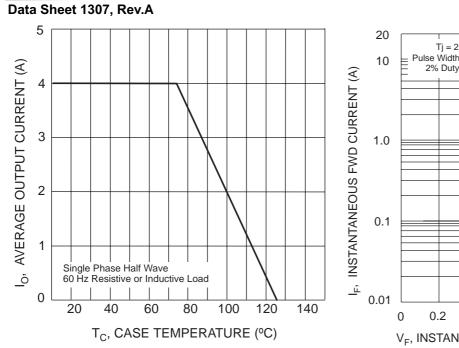
Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	KBL 400	KBL 401	KBL 402	KBL 404	KBL 406	KBL 408	KBL 410	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	VR(RMS)	35	70	140	280	420	560	700	V
Average Rectified Output Current @T _C = 75°C	lo	4.0							Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	Ігѕм	150						А	
Forward Voltage (per element) @I _F = 2.0A	VFM	1.1							V
Peak Reverse Current @T _C = 25°C At Rated DC Blocking Voltage @T _C = 100°C	lR	10 1.0						μA mA	
Rating for Fusing (t < 8.3ms) (Note 1)	l ² t	166						A ² s	
Typical Thermal Resistance (Note 2)	R_{θ} JC	19							K/W
Operating and Storage Temperature Range	Тj, Tsтg	-65 to +125						°C	

*Glass Passivated forms are available upon request.

- Note: 1. Non-repetitive for t > 1ms and < 8.3ms.
 - 2. Thermal resistance junction to case per element mounted on PC board with 13.0x13.0x0.03mm thick land areas.

[•] World Wide Web Site - http://www.sensitron.com • E-Mail Address - sales@sensitron.com •





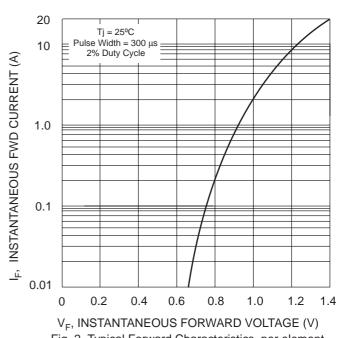


Fig. 2 Typical Forward Characteristics, per element

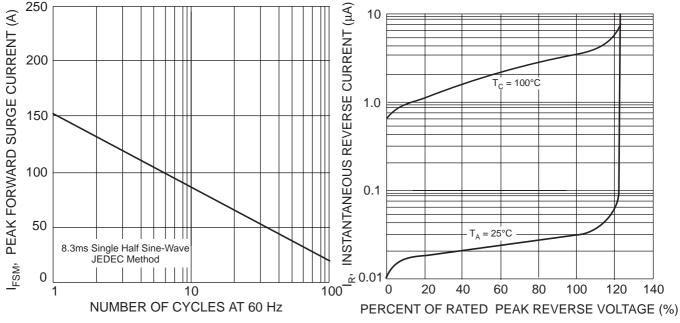


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

Fig. 4 Typical Reverse Characteristics, per element



TECHNICAL DATA

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